APPLICA	BLE STANI	DARD										
OPERATING TEMPERATUR		E RANGE	-55 °C TO 85 °C (1)		TE		ORAGE MPERATURE RANGE		-10 °C TO 60 °C			
RATING	VOLTAGE		50 V AC		RA	NGE	HUMIDITY		RELATIVE HUMIDITY 8 (NOT DEWED)			
	CURRENT		0.5 A	l l	PERATIN NGE	ERATING HUMIDITY NGE						
			SPEC	IFICA	ATION	IS						
IT	EM	TEST METHOD				REQUIREMENTS				ПQТ	- A1	
CONSTRU										1 ~ .	1,	
		VISUALL	Y AND BY MEASURING INS	STRUME	NT.	ACCO	RDING TO D	DRAV	VING.	×	×	
MARKING		CONFIRMED VISUALLY.								×	×	
	CHARACT					_						
CONTACT RESISTANCE		100 mA(DC OR 1000Hz)				70 mΩ MAX .				×	-	
INSULATION RESISTANCE VOLTAGE PROOF		100 V DC. 150 V AC FOR 1 min.				100 MΩMIN. NO FLASHOVER OR BREAKDOWN.			×	<u> </u>		
	CAL CHAR					INO FL	ASHOVER	OR BI	REAKDOVIN.	×	×	
INSERTION A			ED BY APPLICABLE CONN	IFCTOR		linser:	TION FORC	:F:	84 N MAX.	Τ×	Τ_	
WITHDRAWAL FORCES		INDICATE BY AN EIGABLE GOININE OF ON.			•	WITHDRAWAL FORCE: 10.3 N MIN.						
MECHANICAL OPERATION		50 TIMES INSERTIONS AND EXTRACTIONS.			S.	 CONTACT RESISTANCE: Δ VARIATION FROM INITIAL VALUE 20 mΩ OR LESS. NO DAMAGE, CRACK AND LOOSENESS OF PARTS. 					_	
VIBRATION		FREQUENCY 10 TO 55 TO 10Hz, APPROX 5min SINGLE AMPLITUDE: 0.75 mm, 10 CYCLES FOR 3 DIRECTIONS.				NO ELECTRICAL DISCONTINUITY OF 1 μs. NO DAMAGE, CRACK AND LOOSENESS				×	-	
SHOCK		490 m/s ² , DURATION OF PULSE 11 ms AT 3 TIMES FOR 3 DIRECTIONS.				OF PARTS.					<u> </u>	
ENVIRON	MENTAL C											
DAMP HEAT (STEADY STATE)		EXPOSED AT 40±2 °C, 90 ~ 95 %, 96 h.			6 h.	① CONTACT RESISTANCE: ⚠ VARIATION FROM INITIAL VALUE 20 mΩ				×	_	
RAPID CHANGE OF TEMPERATURE		TEMPERATURE -55 \rightarrow +85 °C TIME 30 \rightarrow 30 min. UNDER 5 CYCLES. (RELOCATION TIME TO CHAMBER:WITHIN 2~3 MIN)				OR LESS. ② INSULATION RESISTANCE :100 MΩ MIN. ③ NO DAMAGE, CRACK AND LOOSENESS OF PARTS.				×	-	
COLD		EXPOSED AT -55°C, 96 h			① CONTACT RESISTANCE: Δ VARIATION FROM INITIAL VALUE 20 mΩ				×	-		
DRY HEAT		EXPOSED AT 85°C, 96 h			OR LESS. ② NO DAMAGE, CRACK AND LOOSENESS OF PARTS.				×	-		
SULFUR DIOXIDE		96 h.	POSED AT 25±2°C, 75±5%RH, 25 PPM FOR h. EST STANDARD: JIS C 60068)			 NO DEFECT SUCH AS CORROSION WHICH IMPAIRS THE FUNCTION OF CONNECTOR. CONTACT RESISTANCE: Δ VARIATION FROM INITIAL VALUE 20 mΩ OR LESS. 				2	-	
RESISTANCE TO SOLDERING HEAT		PEAK T	FLOW SOLDERING : AK TMP : 260°CMAX FLOW TMP: 220°CMIN FOR 60sec DEDERING IRONS : 360°C MAX. FOR 5 sec.			NO DEFORMATION OF CASE OF EXCESSIVE LOOSENESS OF THE TERMINAL.				×	-	
SOLDERABILITY		SOLDER	LDERED AT SOLDER TEMPERATURE 0±3°C FOR IMMERSION DURATION, 3 sec.			A NEW UNIFORM COATING OF SOLDER SHALL COVER A MINIMUM OF 95 % OF THE SURFACE BEING IMMERSED.				×	_	
COUN	T DE	ESCRIPTION	ON OF REVISIONS		DESIG	3NED			CHECKED		ATE	
1 4		DIS	l l		KT. [KI. HIROKAWA		11. 11. 24	
	²⁾ "STORAGE" ME	ANS A LON	RISE CAUSED BY CURRENT-CARRYING. IG-TERM STORAGE STATE UCT BEFORE ASSEMBLY TO PCB.			APPROVED CHECKED		-			08. 22 08. 12	
TON THE GROOLD PROD						DESIGNED		D	KT. DO I	11. 08. 1		
Unless otherwise specified, refe			er to JIS-C-5402.			DRAWN			KT. DO I	11. 08. 12		
·					RAWING NO. ELC4-336329-				9-00			
wc	SF	PECIFICATION SHEET			PART NO.		FX20-120P-0. 5SV20					
HS.	HIR	OSE EI	ECTRIC CO., LTD.		CODE	E NO.	CL5	70-	1011-4-00	\triangle	1/1	